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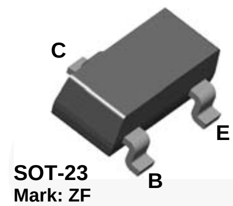
March 2014

MMBT4126
PNP General-Purpose Amplifier

Description

This device is designed for general-purpose amplifier and switching applications at collector currents to 10 µA as a switch and to 100 mA as an amplifier.



Ordering Information

Part Number	Marking	Package	Packing Method
MMBT4126	ZF	SOT-23 3L	Tape and Reel

Absolute Maximum Ratings[(1),(2)]

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CEO}	Collector-Emitter Voltage	-25	V
V_{CBO}	Collector-Base Voltage	-25	V
V_{EBO}	Emitter-Base Voltage	-4	V
I_C	Collector Current - Continuous	-200	mA
T_J , T_{STG}	Junction and Storage Temperature Range	-55 to +150	°C

Notes:

1. These ratings are based on a maximum junction temperature of 150°C.
2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

Thermal Characteristics[3]

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Max.	Unit
P_D	Total Device Dissipation	350	mW
	Derate Above T_A = 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

Note:

3. Device mounted on FR-4 PCB 1.6 inch X 1.6 inch X 0.06 inch.

Electrical Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	I_C = -1.0 mA, I_B = 0	-25		V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	I_C = -10 μA, I_E = 0	-25		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	I_E = -10 μA, I_C = 0	-4.0		V
I_{CBO}	Collector Cut-Off Current	V_{CB} = -20 V, I_E = 0		-50	nA
I_{EBO}	Emitter Cut-Off Current	V_{EB} = -3.0 V, I_C = 0		-50	nA
h_{FE}	DC Current Gain[4]	I_C = -2.0 mA, V_{CE} = -1.0 V	120	360	
		I_C = -50 mA, V_{CE} = -1.0 V	60		
$V_{CE}(sat)$	Collector-Emitter Saturation Voltage[4]	I_C = -50 mA, I_B = -5.0 mA		-0.4	V
$V_{BE}(sat)$	Base-Emitter Saturation Voltage[4]	I_C = -50 mA, I_B = -5.0 mA		-0.95	V
f_T	Current Gain - Bandwidth Product	I_C = -10 mA, V_{CE} = -20 V, f = 100 MHz	250		MHz
C_{ib}	Input Capacitance	V_{EB} = -0.5 V, I_C = 0, f = 1.0 MHz		10	pF
C_{cb}	Collector-Base Capcitance	V_{CB} = -5.0 V, I_E = 0, f = 100 kHz		4.5	pF
h_{fe}	Small-Signal Current Gain	I_C = -2.0 mA, V_{CE} = -10 V, f = 1.0 kHz	120	480	
NF	Noise Figure	I_C = -100 μA, V_{CE} = -5.0 V, R_S = -1.0 kΩ, f = 10 Hz to 15.7 kHz		4.0	dB

Note:

4. Pulse test: pulse width ≤ 300 μs, duty cycle ≤ 2.0%.

Typical Performance Characteristics

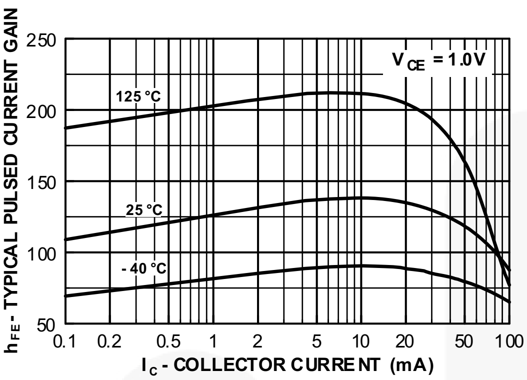


Figure 1. Typical Pulsed Current Gain vs. Collector Current

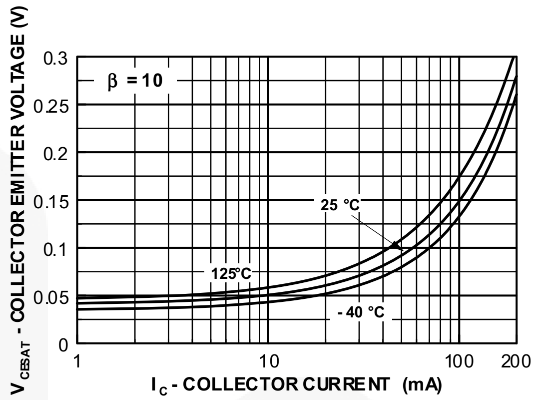


Figure 2. Collector-Emitter Saturation Voltage vs. Collector Current

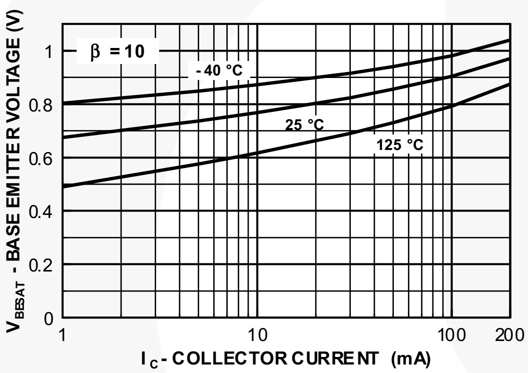


Figure 3. Base-Emitter Saturation Voltage vs. Collector Current

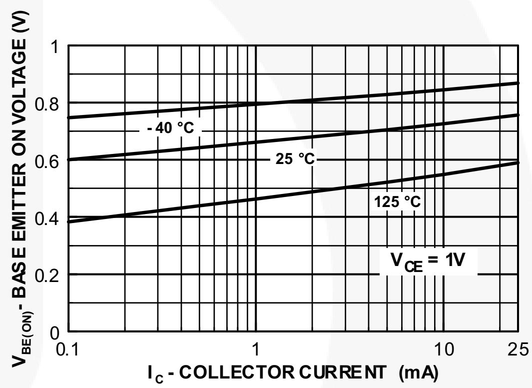


Figure 4. Base-Emitter On Voltage vs. Collector Current

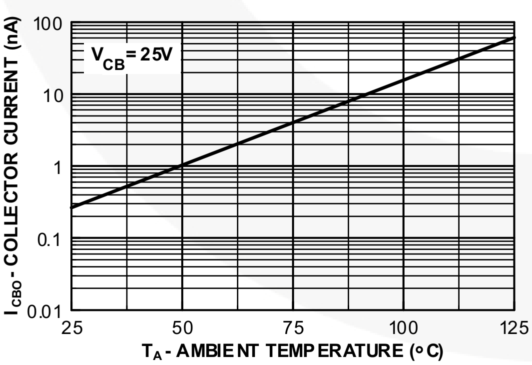


Figure 5. Collector Cut-Off Current vs. Ambient Temperature

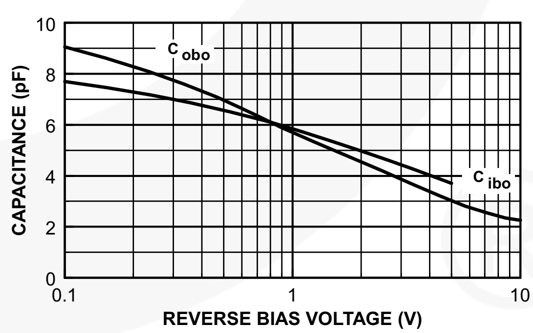


Figure 6. Common-Base Open-Circuit Input and Output Capacitance vs. Reverse-Bias Voltage

Typical Performance Characteristics (Continued)

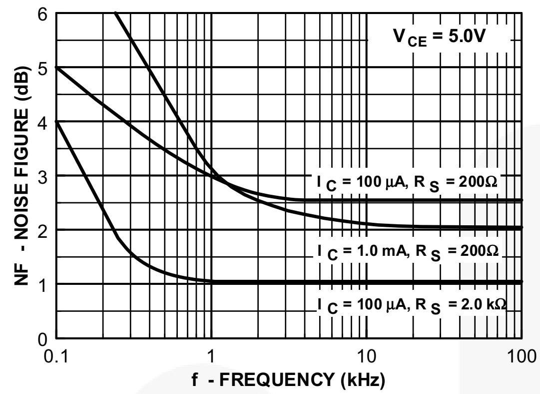


Figure 7. Noise Figure vs. Frequency

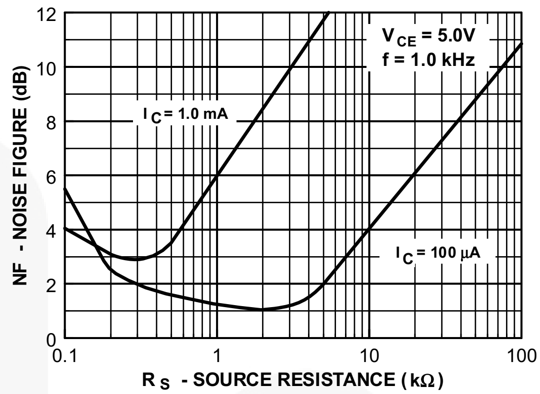


Figure 8. Noise Figure vs. Source Resistance

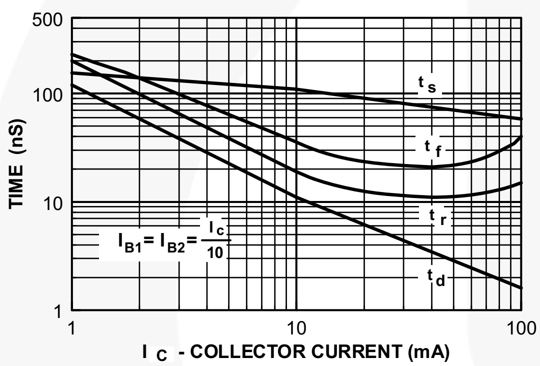


Figure 9. Switching Times vs. Collector Current

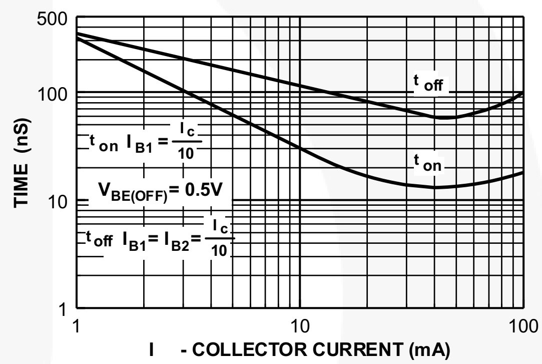


Figure 10. Turn-On and Turn-Off Times vs. Collector Current

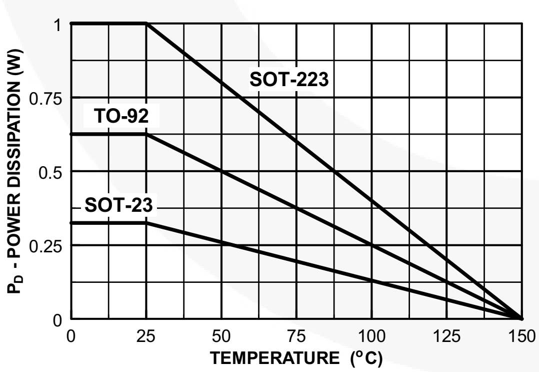


Figure 11. Power Dissipation vs. Ambient Temperature

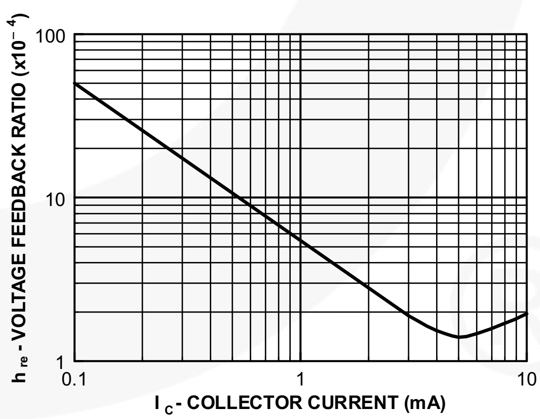


Figure 12. Voltage Feedback Ratio

Typical Performance Characteristics (Continued)

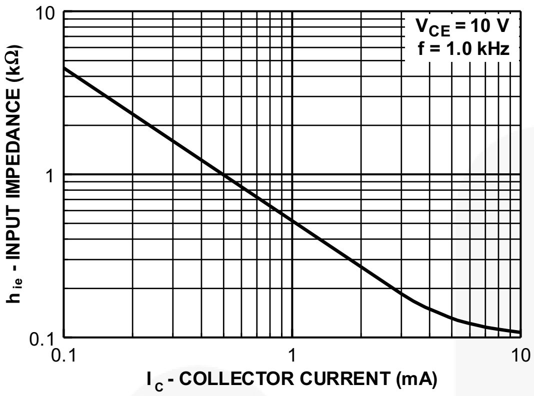


Figure 13. Input Impedance

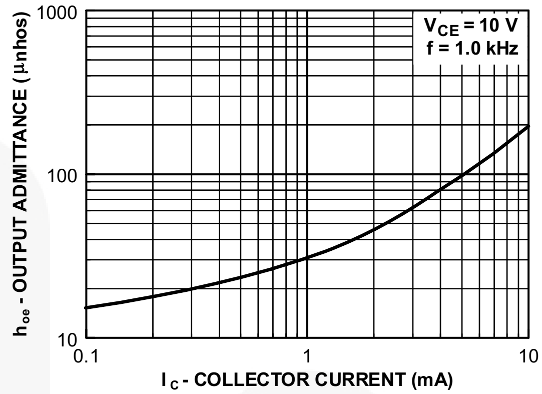


Figure 14. Output Admittance

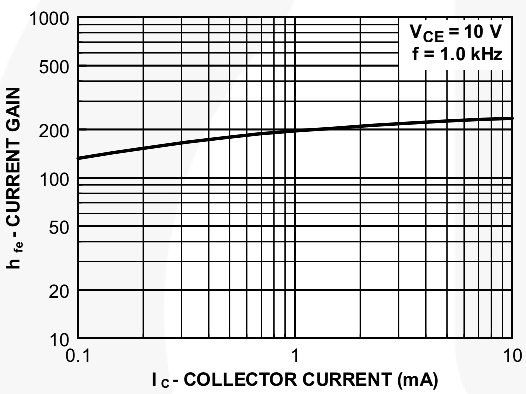


Figure 15. Current Gain

Physical Dimensions

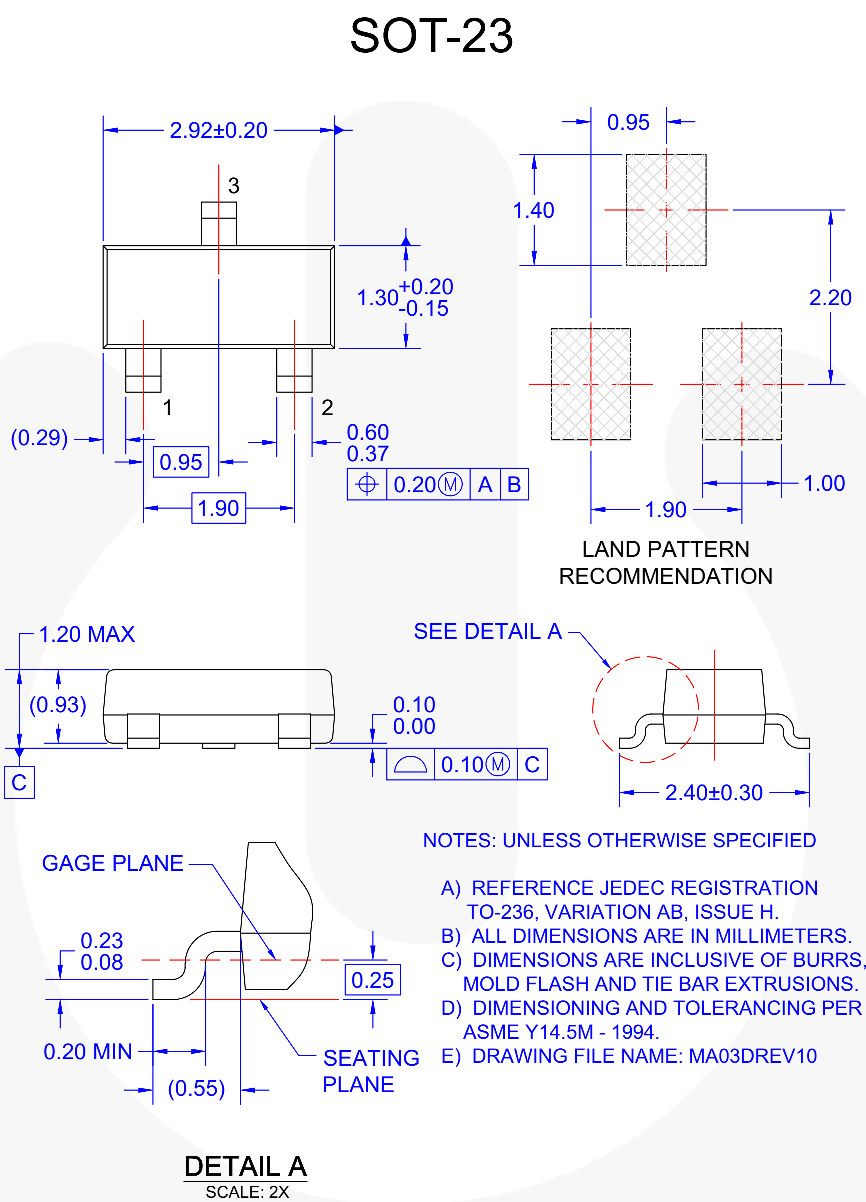


Figure 16. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE (ACTIVE)

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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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Rev. I68

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